CD54ACT163 . . . F PACKAGE

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- Inputs Are TTL-Voltage Compatible
- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Synchronous Counting
- Synchronously Programmable

#### description/ordering information

The 'ACT163 devices are 4-bit binary counters. These synchronous, presettable counters feature an internal carry look-ahead for application in high-speed counting designs. Synchronous operation is provided by having all flip-flops

CD74ACT163...E OR M PACKAGE (TOP VIEW) 16 V<sub>CC</sub> CLR CLK 2 15 RCO А 🛮 з 14 Q<sub>A</sub> B 🛮 4 13 Q<sub>B</sub> C ∏ 5 12 Q<sub>C</sub> DΠ 6 11 Q<sub>D</sub> 10 ENT ENP [] 7 9 LOAD GND []

clocked simultaneously so that the outputs change, coincident with each other, when instructed by the count-enable (ENP, ENT) inputs and internal gating. This mode of operation eliminates the output counting spikes normally associated with synchronous (ripple-clock) counters. A buffered clock (CLK) input triggers the four flip-flops on the rising (positive-going) edge of the clock waveform.

The counters are fully programmable; that is, they can be preset to any number between 0 and 9 or 15. Presetting is synchronous; therefore, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs.

The clear function is synchronous. A low level at the clear ( $\overline{\text{CLR}}$ ) input sets all four of the flip-flop outputs low after the next low-to-high transition of CLK, regardless of the levels of the enable inputs. This synchronous clear allows the count length to be modified easily by decoding the Q outputs for the maximum count desired. The active-low output of the gate used for decoding is connected to  $\overline{\text{CLR}}$  to synchronously clear the counter to 0000 (LLLL).

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. ENP, ENT, and a ripple-carry output (RCO) are instrumental in accomplishing this function. Both ENP and ENT must be high to count, and ENT is fed forward to enable RCO. Enabling RCO produces a high-level pulse while the count is maximum (9 or 15, with  $Q_A$  high). This high-level overflow ripple-carry pulse can be used to enable successive cascaded stages. Transitions at ENP or ENT are allowed, regardless of the level of CLK.

These devices feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or  $\overline{\text{LOAD}}$ ) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) is dictated solely by the conditions meeting the stable setup and hold times.

#### ORDERING INFORMATION

| TA             | PAC      | KAGE†         | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |  |
|----------------|----------|---------------|--------------------------|---------------------|--|
|                | PDIP – E | Tube          | CD74ACT163E              | CD74ACT163E         |  |
| -55°C to 125°C | SOIC - M | Tube          | CD74ACT163M              | ACT163M             |  |
| -33 C to 123 C | 301C - W | Tape and reel | CD74ACT163M96            | ACT TOSIVI          |  |
|                | CDIP – F | Tube          | CD54ACT163F3A            | CD54ACT163F3A       |  |



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#### **FUNCTION TABLE**

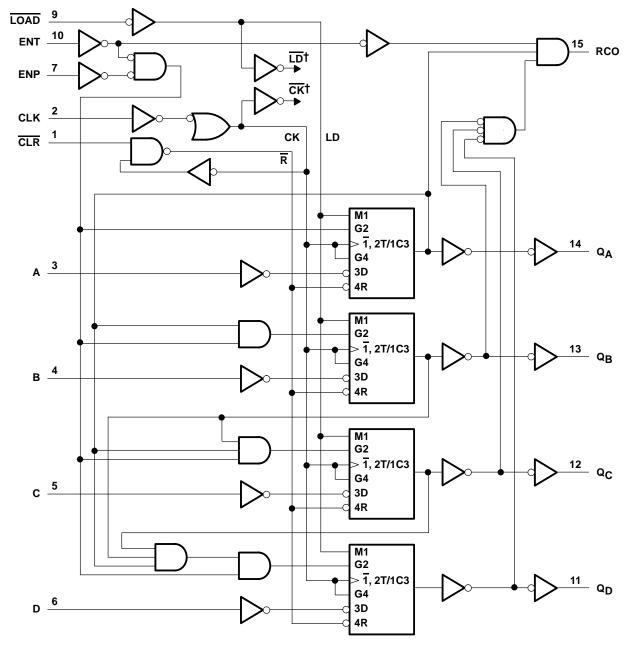
|     |            | IN  | IPUTS |      | OUT     | PUTS           | FUNCTION |               |  |
|-----|------------|-----|-------|------|---------|----------------|----------|---------------|--|
| CLR | CLK        | ENP | ENT   | LOAD | A,B,C,D | Qn             | RCO      | FUNCTION      |  |
| L   | <b>↑</b>   | Χ   | Χ     | Χ    | Χ       | L              | L        | Reset (clear) |  |
| h   | $\uparrow$ | Х   | Х     | I    | I       | L              | L        | Parallel load |  |
| h   | $\uparrow$ | Χ   | Χ     | I    | h       | Н              | Note 1   | Parallel load |  |
| h   | <b>↑</b>   | h   | h     | h    | Χ       | Count          | Note 1   | Count         |  |
| h   | Χ          | !   | Χ     | h    | Х       | q <sub>n</sub> | Note 1   | Inhibit       |  |
| h   | Χ          | Χ   | I     | h    | Χ       | q <sub>n</sub> | L        | HIHIDIL       |  |

H = high level, L = low level, X = don't care, h = high level one setup time prior to the CLK low-to-high transition, I = low level one setup time prior to the CLK low-to-high transition, q = the state of the referenced output prior to the CLK low-to-high transition, and  $\uparrow$  = CLK low-to-high transition.

NOTE 1: The RCO output is high when ENT is high and the counter is at terminal count (HHHH).



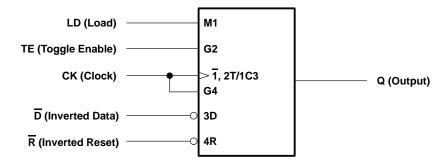
## logic diagram (positive logic)



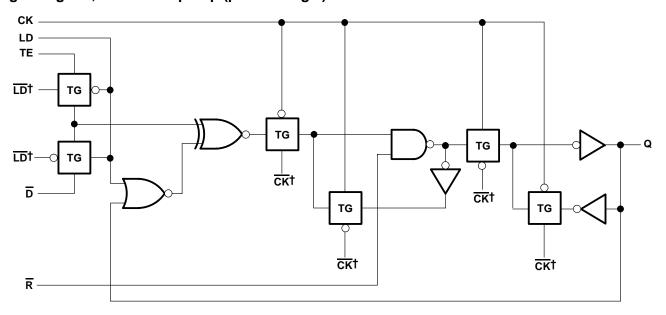
<sup>†</sup> For simplicity, routing of complementary signals  $\overline{\mathsf{LD}}$  and  $\overline{\mathsf{CK}}$  is not shown on this overall logic diagram. The uses of these signals are shown on the logic diagram of the D/T flip-flops.

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#### logic symbol, each D/T flip-flop



### logic diagram, each D/T flip-flop (positive logic)

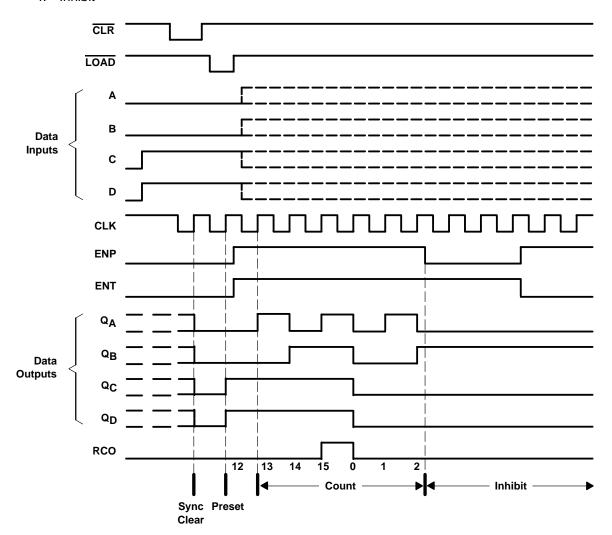


 $<sup>^{\</sup>dagger}$  The origins of  $\overline{LD}$  and  $\overline{CK}$  are shown in the logic diagram of the overall device.

#### typical clear, preset, count, and inhibit sequence

The following sequence is illustrated below:

- 1. Clear outputs to zero (synchronous)
- 2. Preset to binary 12
- 3. Count to 13, 14, 15, 0, 1, and 2
- 4. Inhibit



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>  | 0.5 V to 6 V   |
|--|----------------|
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 2)                                   | ±20 mA         |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) (see Note 2) | ±50 mA         |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )   | ±50 mA         |
| Continuous current through V <sub>CC</sub> or GND  | ±100 mA        |
| Package thermal impedance, θ <sub>JA</sub> (see Note 3): E package   | 67°C/W         |
| M package  | 73°C/W         |
| Storage temperature range, T <sub>Sto</sub>  | -65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 4)

|                 |                                    | T <sub>A</sub> = 25°C |     |     | –55°C to<br>125°C |     | –40°C to<br>85°C |    |
|-----------------|------------------------------------|-----------------------|-----|-----|-------------------|-----|------------------|----|
|                 |                                    | MIN                   | MAX | MIN | MAX               | MIN | MAX              |    |
| Vcc             | Supply voltage                     | 4.5                   | 5.5 | 4.5 | 5.5               | 4.5 | 5.5              | V  |
| VIH             | High-level input voltage           | 2                     |     | 2   |                   | 2   |                  | V  |
| V <sub>IL</sub> | Low-level input voltage            |                       | 0.8 |     | 0.8               |     | 0.8              | V  |
| ٧ <sub>I</sub>  | Input voltage                      | 0                     | VCC | 0   | VCC               | 0   | VCC              | V  |
| ٧o              | Output voltage                     | 0                     | VCC | 0   | VCC               | 0   | VCC              | V  |
| IOH             | High-level output current          |                       | -24 |     | -24               |     | -24              | mA |
| l <sub>OL</sub> | Low-level output current           |                       | 24  |     | 24                |     | 24               | mA |
| Δt/Δν           | Input transition rise or fall rate |                       | 10  |     | 10                |     | 10               | ns |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>3.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER          | TEST COND                               | Vcc                                 | T <sub>A</sub> = 25°C | –55°C to<br>125°C | –40°C to<br>85°C | UNIT    |         |  |
|--------------------|---|-------------------------------------|-----------------------|-------------------|------------------|---------|---------|--|
|                    |   |                                     |                       | MIN MAX           | MIN MAX          | MIN MAX |         |  |
|                    |   | I <sub>OH</sub> = -50 μA            | 4.5 V                 | 4.4               | 4.4              | 4.4     |         |  |
| Vou                | VI = VIH or VIL                         | $I_{OH} = -24 \text{ mA}$           | 4.5 V                 | 3.94              | 3.7              | 3.8     | V       |  |
| <sup>V</sup> OH    | v  = v H or v L                         | $I_{OH} = -50 \text{ mA}^{\dagger}$ | 5.5 V                 | 1                 | 3.85             | -       | V       |  |
|                    |   | $I_{OH} = -75 \text{ mA}^{\dagger}$ | 5.5 V                 | -                 | -                | 3.85    |         |  |
|                    | VI = VIH or VIL                         | I <sub>OL</sub> = 50 μA             | 4.5 V                 | 0.1               | 0.1              | 0.1     | <b></b> |  |
| \/a.               |   | I <sub>OL</sub> = 24 mA             | 4.5 V                 | 0.36              | 0.5              | 0.44    |         |  |
| VOL                |   | $I_{OL} = 50 \text{ mA}^{\dagger}$  | 5.5 V                 | _                 | 1.65             | _       |         |  |
|                    |   | $I_{OL} = 75 \text{ mA}^{\dagger}$  | 5.5 V                 | _                 | _                | 1.65    |         |  |
| lį                 | $V_I = V_{CC}$ or GND                   |                                     | 5.5 V                 | ±0.1              | ±1               | ±1      | μΑ      |  |
| ICC                | $V_I = V_{CC}$ or GND,                  | IO = 0                              | 5.5 V                 | 8                 | 160              | 80      | μΑ      |  |
| Δl <sub>CC</sub> ‡ | V <sub>I</sub> = V <sub>CC</sub> -2.1 V |                                     | 4.5 V to<br>5.5 V     | 2.4               | 3                | 2.8     | mA      |  |
| Ci                 |   |                                     |                       | 10                | 10               | 10      | pF      |  |

<sup>†</sup> Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C. ‡ Additional quiescent supply current per input pin, TTL inputs high, 1 unit load

#### **ACT INPUT LOAD TABLE**

| INPUT         | UNIT LOAD |
|---------------|-----------|
| A, B, C, or D | 0.13      |
| CLK           | 1         |
| CLR, ENT      | 0.83      |
| LOAD          | 0.67      |
| ENP           | 0.5       |

Unit Load is  $\Delta I_{CC}$  limit specified in electrical characteristics table (e.g., 2.4 mA at 25°C).

#### timing requirements over recommended operating conditions (unless otherwise noted)

|                 |                         |                 | –55°(<br>125       |     | –40°(<br>85° |     | UNIT |  |
|-----------------|-------------------------|-----------------|--------------------|-----|--------------|-----|------|--|
|                 |                         |                 | MIN                | MAX | MIN          | MAX |      |  |
| fclock          | Clock frequency         |                 |                    | 80  |              | 91  | MHz  |  |
| t <sub>W</sub>  | Pulse duration          | CLK high or low | 6.2                |     | 5.4          |     | ns   |  |
|                 | Setup time, before CLK↑ | A, B, C, or D   | 5                  |     | 4.4          |     | ns   |  |
| ١.              |                         | ENP or ENT      | 6                  |     | 5.3          |     |      |  |
| t <sub>su</sub> | Setup time, before CLK  | LOAD low        | 7.5                |     | 6.6          |     |      |  |
|                 |                         | CLR inactive    | 7.5 6.6<br>7.5 6.6 |     | 1 1          |     |      |  |
|                 |                         | A, B, C, or D   | 0                  |     | 0            |     |      |  |
| ١.              | Hold time, after CLK↑   | ENP or ENT      | 0                  |     | 0            |     | 1    |  |
| <sup>t</sup> h  | noid tille, after CLN1  | LOAD low        | 0                  |     | 0            |     | ns   |  |
|                 |                         | 0               |                    | 0   |              |     |      |  |

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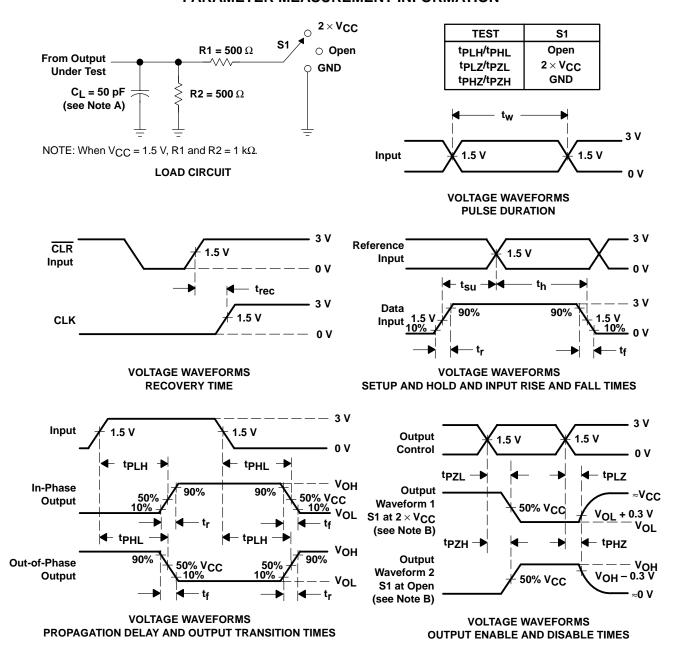
# switching characteristics over recommended operating conditions, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | –55°<br>125 |      | –40°0<br>85° | UNIT |     |
|------------------|-----------------|----------------|-------------|------|--------------|------|-----|
|                  | (INFOT)         | (001F01)       | MIN         | MAX  | MIN          | MAX  |     |
| f <sub>max</sub> |                 |                | 80          |      | 91           |      | MHz |
| <sup>t</sup> pd  | CLK             | RCO            | 4.2         | 16.7 | 4.3          | 15.2 |     |
|                  |                 | Any Q          | 4.1         | 16.5 | 4.2          | 15   | ns  |
|                  | ENT             | RCO            | 2.7         | 10.8 | 2.8          | 9.8  |     |

## operating characteristics, $T_A = 25^{\circ}C$

|                 | PARAMETER                     | TEST CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | No load         | 66  | pF   |

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>I</sub> includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ . Phase relationships between waveforms are arbitrary.
- D. For clock inputs, f<sub>max</sub> is measured with the input duty cycle at 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. tpLH and tpHL are the same as tpd.
- G. tp7| and tp7H are the same as ten.
- H. tpLz and tpHz are the same as tdis.
- I. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







6-Feb-2020

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|-------------------------|---------|
| CD54ACT163F3A    | ACTIVE | CDIP         | J                  | 16   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | CD54ACT163F3A           | Samples |
| CD74ACT163E      | ACTIVE | PDIP         | N                  | 16   | 25             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | N / A for Pkg Type | -55 to 125   | CD74ACT163E             | Samples |
| CD74ACT163M      | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | ACT163M                 | Samples |
| CD74ACT163M96    | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | ACT163M                 | Samples |
| CD74ACT163M96E4  | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | ACT163M                 | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



#### PACKAGE OPTION ADDENDUM

6-Feb-2020

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#### OTHER QUALIFIED VERSIONS OF CD54ACT163, CD74ACT163:

■ Catalog: CD74ACT163

Military: CD54ACT163

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

**PACKAGE MATERIALS INFORMATION** 

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#### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device        | Package<br>Type | Package<br>Drawing |    |      | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD74ACT163M96 | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |

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#### \*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74ACT163M96 | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |

## D (R-PDS0-G16)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



## D (R-PDSO-G16)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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